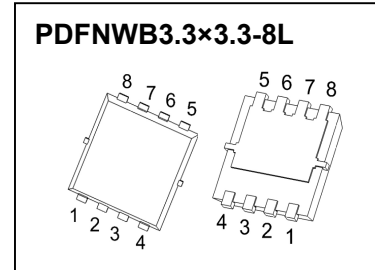




# PDFNWB3.3×3.3-8L Plastic-Encapsulate MOSFETS

## AB50N03 N-Channel Power MOSFET

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
HEX	4.7{ O FEX	50CE
	6.5{ O I EX	



### DESCRIPTION

The AB50N03 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications

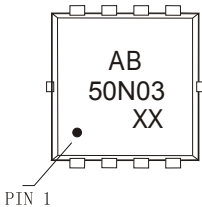
### FEATURES

- Battery switch
- Load switch
- High density cell design for ultra low  $R_{DS(ON)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

### APPLICATIONS

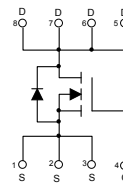
- SMPS and general purpose applications
- Hard switched and high frequency circuits
- Uninterruptible Power Supply

### MARKING



AB50N03 = Part No.  
 Solid dot = Pin1 indicator.  
 XX = Code.

### EQUIVALENT CIRCUIT



### ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	HE	V
Gate-Source Voltage	$V_{GS}$	16	V
Drain Current (DC)	$I_{D(continuous)}$	50	A
Drain Current (Pulse)	$I_{D(pulse)}$	200	A
Gate Charge	$Q_{g(100V)}$	116	nC
Turn-on Delay Time	$t_{d(on)}$	59	nS
Thermal Resistance from Junction to Case	$R_{\theta JC}$	83.3	$^\circ\text{C/W}$
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55~+150	$^\circ\text{C}$

# MOSFET ELECTRICAL CHARACTERISTICS

$T_a=25\text{ }^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Off characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 24V,$ $V_{GS} = 0V$	$T_J = 25\text{ }^\circ\text{C}$		1.0	$\mu A$
			$T_J = 125\text{ }^\circ\text{C}$		100	
Gate-body leakage current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$			$\pm 100$	nA
<b>On characteristics</b> <sup>④</sup>						
Gate-threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.5	2.5	V
Static drain-source on-state resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 5A$		4.7	6.5	m $\Omega$
		$V_{GS} = 4.5V, I_D = 5A$		6.5	8.5	m $\Omega$
<b>Dynamic characteristics</b> <sup>④ ⑤</sup>						
Input capacitance	$C_{iss}$	$V_{DS} = 15V, V_{GS} = 0V,$ $f = 1MHz$		1650	3300	pF
Output capacitance	$C_{oss}$			230	460	
Reverse transfer capacitance	$C_{rss}$			210	420	
Gate resistance	$R_g$	$f = 1MHz$		3.4		$\Omega$
<b>Switching characteristics</b> <sup>④ ⑤</sup>						
Total gate charge	$Q_g$	$V_{GS} = 10V,$ $V_{DS} = 20V, I_D = 30A$		34	68	nC
Gate-source charge	$Q_{gs}$			3.4	6.8	
Gate-drain charge	$Q_{gd}$			9.6	19	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 30V, I_D = 1A,$ $R_L = 15\Omega, V_{GS} = 10V,$ $R_G = 6\Omega$		5.0		ns
Turn-on rise time	$t_r$			24		
Turn-off delay time	$t_{d(off)}$			20		
Turn-off fall time	$t_f$			7.5		
<b>Drain-Source Diode Characteristics</b>						
Drain-source diode forward voltage	$V_{SD}$ <sup>④</sup>	$V_{GS} = 0V, I_S = 10A$			1.2	V
Continuous drain-source diode forward current	$I_S$ <sup>①</sup>				50	A
Pulsed drain-source diode forward current	$I_{SM}$ <sup>②</sup>				200	A

Notes:

1.  $T_C = 25\text{ }^\circ\text{C}$  Limited only by maximum temperature allowed.

2.  $P_W \leq 10\mu s$ , Duty cycle  $\leq 1\%$ .

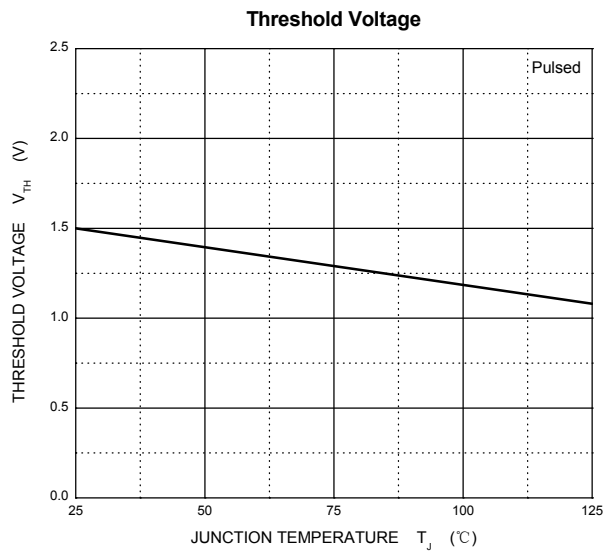
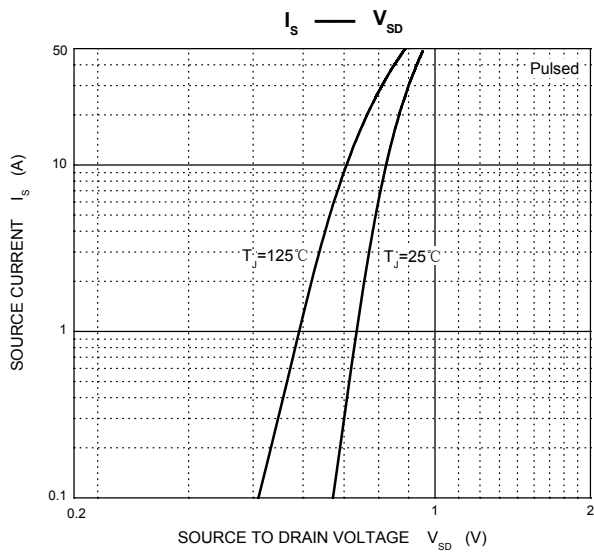
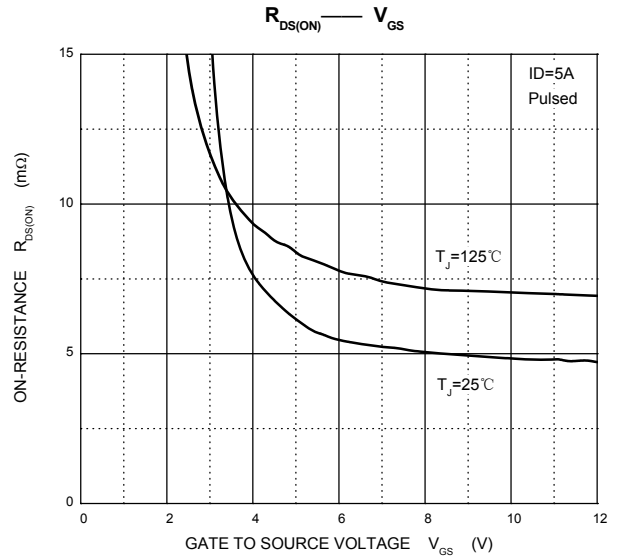
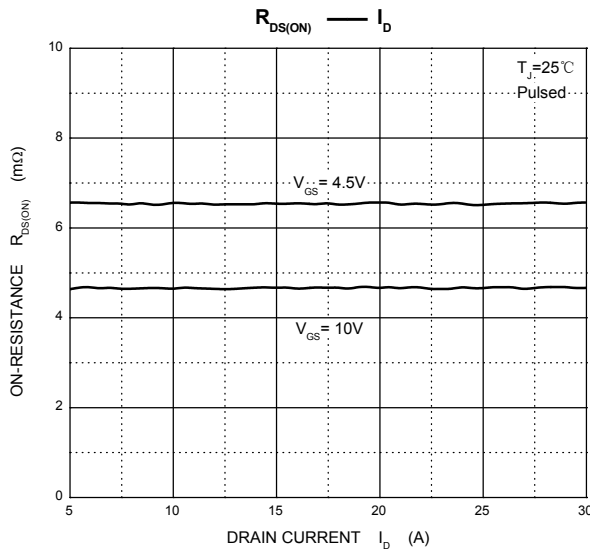
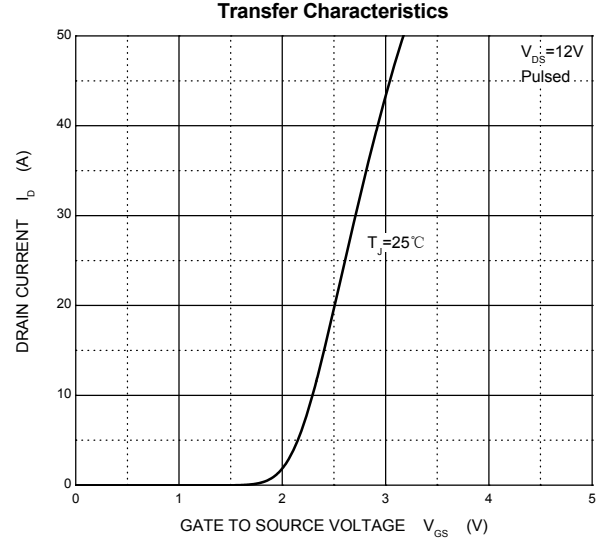
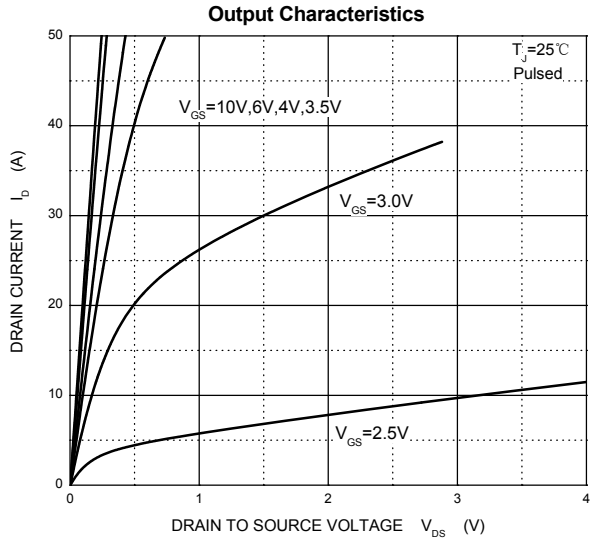
3. EAS condition:  $V_{DD} = 15V, V_{GS} = 10V, L = 0.5mH, R_g = 25\Omega$  Starting  $T_J = 25\text{ }^\circ\text{C}$ .

4. Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .

5. Guaranteed by design, not subject to production.

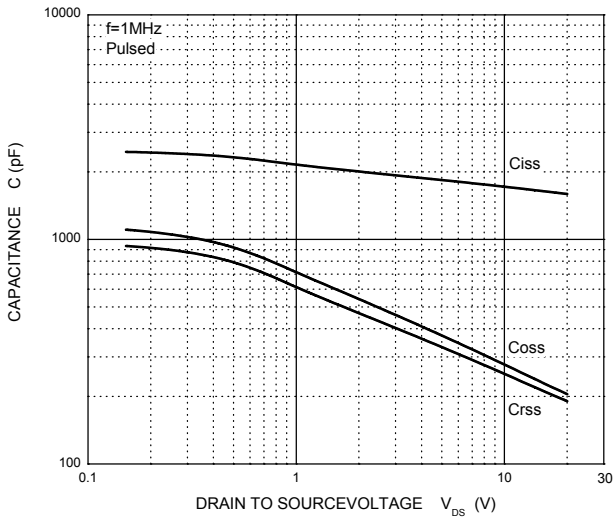
6. The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_a = 25\text{ }^\circ\text{C}$ .

# Typical Characteristics

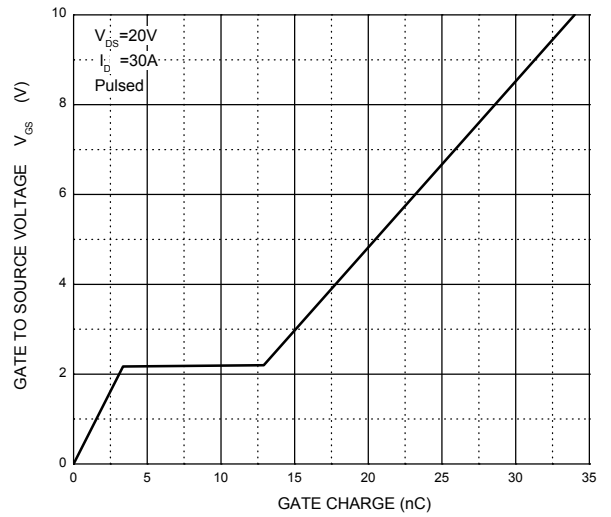


# Typical Characteristics

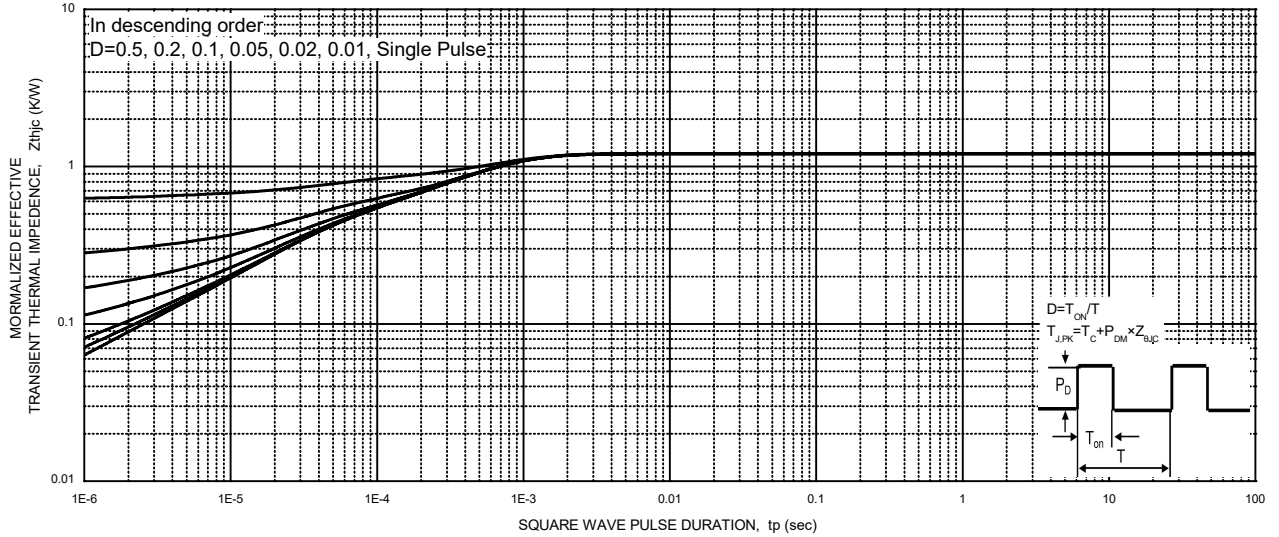
Capacitances



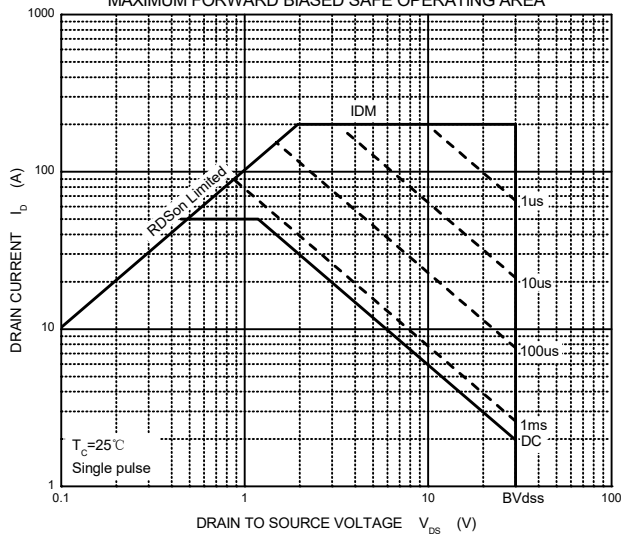
Gate Charge



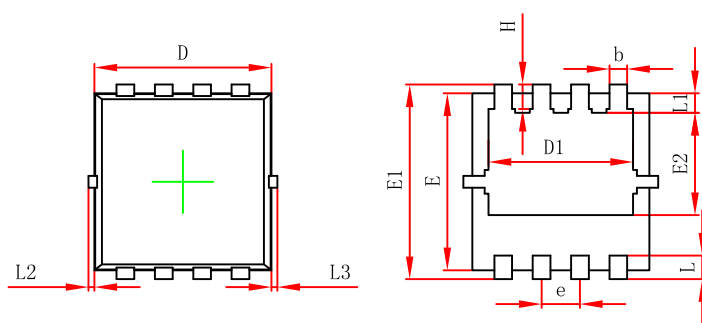
NORMALIZED TYPICAL TRANSIENT THERMAL IMPEDANCE



MAXIMUM FORWARD BIASED SAFE OPERATING AREA

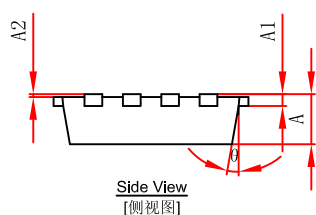


## PDFNWB3.3x3.3-8L Package Outline Dimensions



Top View  
[顶视图]

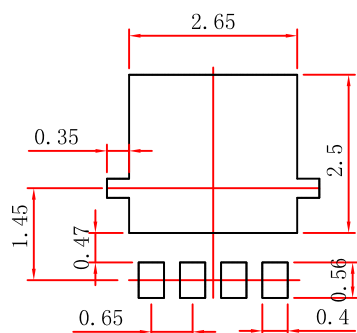
Bottom View  
[背视图]



Side View  
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.		0.006 REF.	
A2	0~0.05		0~0.002	
D	2.900	3.100	0.114	0.122
D1	2.300	2.600	0.091	0.102
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0~0.100		0~0.004	
L3	0~0.100		0~0.004	
H	0.315	0.515	0.012	0.020
θ	9°	13°	9°	13°

## PDFNWB3.3x3.3-8L Suggested Pad Layout

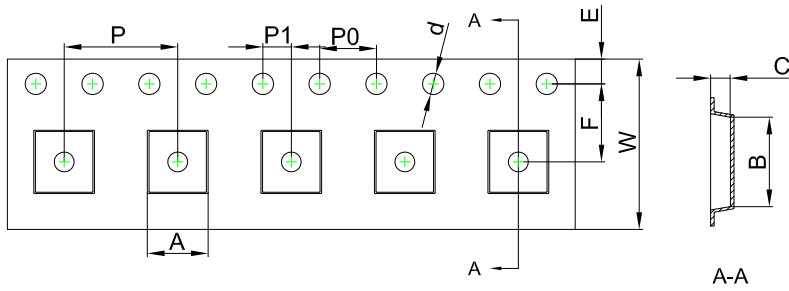


Note:

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05$  mm.
3. The pad layout is for reference purposes only.

# PDFNWB3.3×3.3-8L Tape and Reel

## PDFNWB3.3×3.3-8L Embossed Carrier Tape

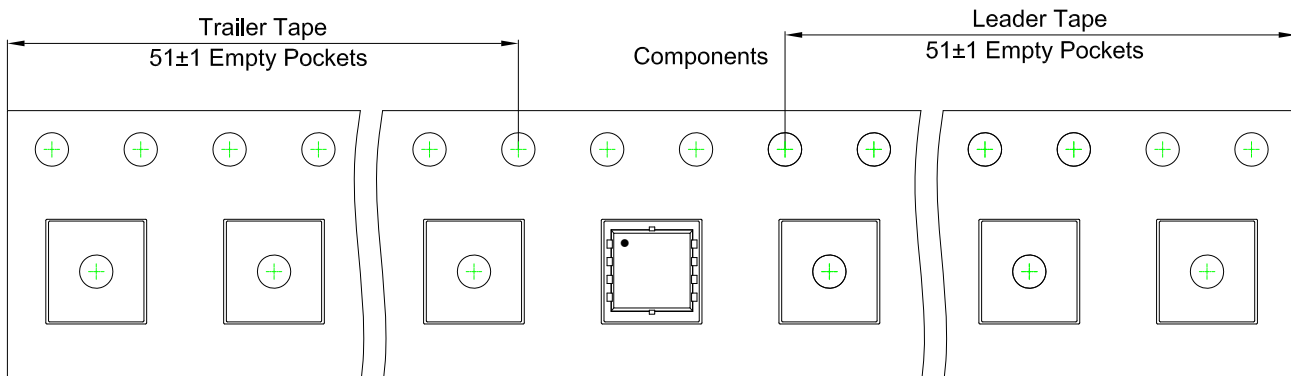


### Packaging Description:

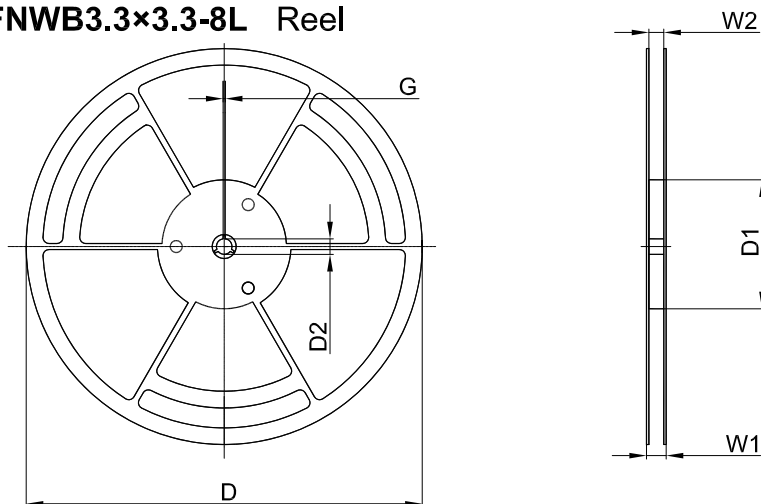
**PDFNWB3.3×3.3-8L** parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 5,000 units per 13" or 33.0 cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
PDFNWB3.3×3.3-8L	3.55	3.55	1.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

## PDFNWB3.3×3.3-8L Tape Leader and Trailer



## PDFNWB3.3×3.3-8L Reel



Dimensions are in millimeter						
Reel Option	D	D1	D2	G	W1	W2
13" Dia	Ø330.00	100.00	13.00	1.90	17.60	12.40

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)
5,000 pcs	13 inch	5,000 pcs	340×336×29	50,000 pcs	353×346×365